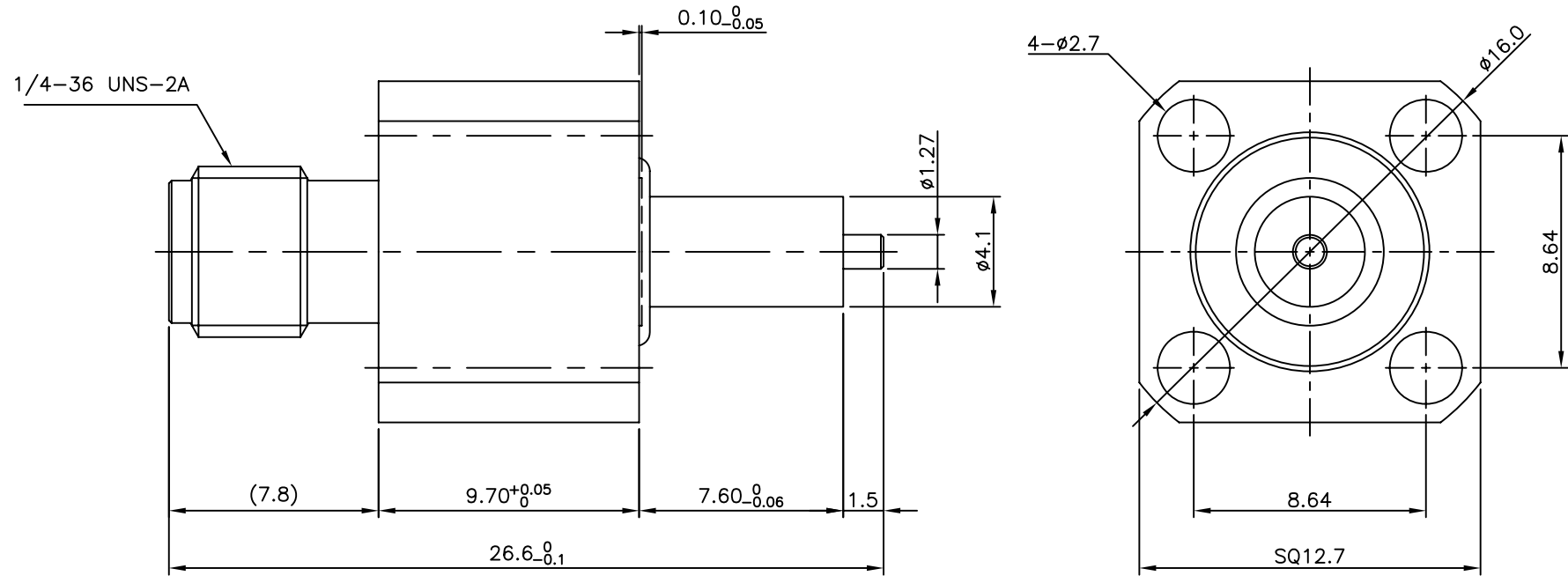


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.11.06.



4	INSULATOR	1	TEFLON		DIN03096-N/1
3	GASKET	1	SILICONE RUB		DGK00020-N/1
2	CONTACT	1	BeCu C17300	Gold Plate (1.27 μ m)	DCT04084-5/1
1	BODY	1	SUS303	Passivate	DBD04573-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 11. 06.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-4H
		DRAWN BY	S.Y.EUN	
FINISH	-	SCALE	4/1	A4 DWG NO. CN03892-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	